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UTILITY PATENT APPLICATION

TRANSMITTAL (Only for new nonprovisional applications under 37 CFR 1.53(b)) Attorney Docket No. P01,0144 First Named Inventor or Application Identifier

Leo M. Higgins, III

Express Mail Label No: # EL843741474US ADDRESS TO: Assistant Commissioner for Patents **Box Patent Application** Washington, DC 20231 APPLICATION ELEMENTS ACCOMPANYING APPLICATION PARTS See MPEP chapter 600 concerning utility patent application contents. 1. X Specification 5. X\ [Total Pages 36] Assignment Papers (cover sheet & documentation) Siemens Dematic Electronics Assembly Systems, Inc. 2. X Drawing(s) (35USC 113) [Total Pages 5] (Faxed copy of original) 3. X Declaration and Power of Attorney [Total Pages 3] Letter under 37 CFR 1.41(c). a. X Newly executed(Faxed copy of original) 7. English Translation Document (if applicable) Copy from prior application (37CFR 1.63(d)) 8. Information Disclosure Copies of IDS (for continuation/divisional with Box 17 completed) Statement (IDS)/PTO-1449 Citations [Note Box 4 Below] Preliminary Amendment DELETION OF INVENTOR(S) 10. X Return Receipt Postcard (MPEP 503) Signed statement attached deleting Inventor(s) named in the prior application. (Should be specifically itemized) see 37 CFR 1.63(d)(2) and 1.33(b). Small Entity Statement filed in prior application, Incorporation By Reference (usable if Box 3b is checked) Statement(s) Status still proper and desired The entire disclosure of the prior application, from which a Certified Copy of Priority Document(s) copy of the oath or declaration is supplied under Box 3b, is considered as being part of the disclosure of the (if foreign priority is claimed) accompanying application and is hereby incorporated by reference therein Other:

- 14. If a CONTINUING APPLICATION, check appropriate box and supply the requisite information:
- The new application being transmitted claims the benefit of prior U.S. Application(s).
- Amend the specification by Inserting, before the first line, the following sentence:
 - This application claims the benefit of U.S. Provisional Application(s) No(s).: 60/272,520 FILED March 1, 2001

Ī			CLAIMS AS F	ILED		
	(1) FOR		(2) NUMBER FILED	(3) NUMBER EXTRA	(4) RATE	(5) BASIC FEE \$740 00
	TOTAL CLAIMS INDEPEND	20 DENT	28	8	\$18 00	\$144 00
	CLAIMS	3	4	1	\$84 00	\$84 00
4		ANY MULTIPLE DEPENDENT CLAIMS? ☐ YES █ NO				
				TOTAL FILING FEE->	\$968 00	

- The Commissioner is hereby authorized to charge any additional fees which may be required in connection with this application, or credit any overpayment to ACCOUNT NO. 501-519. A duplicate copy of this sheet is enclosed.
 - A check in the amount of \$ \$968.00 to cover the filing fee is enclosed.

15. CORRESPONDENCE ADDRESS SCHIFF HARDIN & WAITE

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I hereby certify that the following is being deposited with the United States Postal "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to Hon. Assistant Commissioner of Patents, Washington DC 20231.

Proposed Patent Application for LEO M. HIGGINS entitled "METHOD AND STRUCTURE OF IN-SITU WAFER SCALE POLYMER STUD GRID ARRAY CONTACT FORMATION", consisting of specification, claims, 6 Sheets of drawings, Attorney Docket No. P01,0144

Signature of person mailing application

Name of person mailing application